

IFN3954, IFN3955, IFN3956 Dual Matched N-Channel JFET

Features

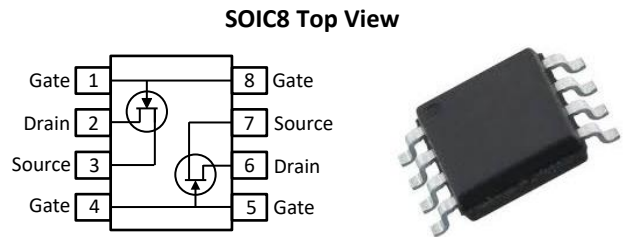
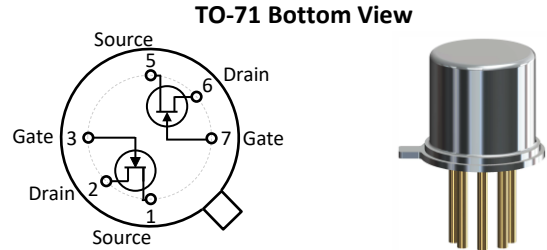
- InterFET [N0016H Geometry](#)
- Typical Noise: 6 nV/√Hz
- Low Ciss: 3.5pF Typical
- High Input Impedance
- RoHS Compliant
- SMT, TH, and Bare Die Package options.

Applications

- Differential Amplifiers
- Low Noise Pre-Amplifier
- High Impedance Amplifier

Description

The -50V InterFET IFN3954, IFN3955, and IFN3956 matched pair JFET's are targeted for high input impedance applications for mid to high frequency designs. Gate leakages are typically 10pA at room temperatures. Parts are matched down to 5mV. The TO-71 package is hermetically sealed and suitable for military applications. Custom specifications, matching, and packaging options are available.



Product Summary

Parameters	IFN3954 Min	IFN3955 Min	IFN3956 Min	Unit
BV _{GSS} Gate to Source Breakdown Voltage	-50	-50	-50	V
I _{DSS} Drain to Source Saturation Current	0.5	0.5	0.5	mA
V _{GS(off)} Gate to Source Cutoff Voltage	-1	-1	-1	V
G _{FS} Forward Transconductance	1000	1000	1000	μS

Ordering Information Custom Part and Binning Options Available

Part Number	Description	Case	Packaging
IFN3954; IFN3955; IFN3956	Through-Hole	TO-71	Bulk
SMP3954; SMP3955; SMP3956	Surface Mount	SOIC8	Bulk
SMP3954TR; SMP3955TR; SMP3956TR	7" Tape and Reel: Max 500 Pieces 13" Tape and Reel: Max 2,500 Pieces	SOIC8	Minimum 500 Pieces Tape and Reel
IFN3954COT; IFN3955COT; IFN3956COT *	Chip Orientated Tray (COT Waffle Pack)	COT	70/Waffle Pack
IFN3954CFT; IFN3955CFT; IFN3956CFT *	Chip Face-up Tray (CFT Waffle Pack)	CFT	70/Waffle Pack

* Bare die packaged options are designed for matched specifications but not 100% tested



Disclaimer: It is the Buyers responsibility for designing, validating and testing the end application under all field use cases and extreme use conditions. Guaranteeing the application meets required standards, regulatory compliance, and all safety and security requirements is the responsibility of the Buyer. These resources are subject to change without notice.

Electrical Characteristics

Maximum Ratings (@ $T_A = 25^\circ\text{C}$, Unless otherwise specified)

Parameters	Value	Unit
V_{RGS} Reverse Gate Source and Gate Drain Voltage	-50	V
I_{FG} Continuous Forward Gate Current	50	mA
P_D Continuous Device Power Dissipation	250	mW
P Power Derating	4.3	mW/ $^\circ\text{C}$
T_J Operating Junction Temperature	-55 to 150	$^\circ\text{C}$
T_{STG} Storage Temperature	-65 to 175	$^\circ\text{C}$

Static Characteristics (@ $T_A = 25^\circ\text{C}$, Unless otherwise specified)

Parameters	Conditions	IFN3954, IFN3955, IFN3956			Unit
		Min	Typ	Max	
$V_{(BR)GSS}$ Gate to Source Breakdown Voltage	$I_G = -1\mu\text{A}, V_{DS} = 0\text{V}$	-50			V
I_{GSS} Gate to Source Reverse Current	$V_{GS} = -30\text{V}, V_{DS} = 0\text{V}, T_A = 25^\circ\text{C}$			-100	pA
	$V_{GS} = -30\text{V}, V_{DS} = 0\text{V}, T_A = 125^\circ\text{C}$			-500	nA
I_G Gate Operating Current	$V_{DS} = 20\text{V}, I_D = 200\mu\text{A}, T_A = 25^\circ\text{C}$			-50	pA
	$V_{DS} = 20\text{V}, I_D = 200\mu\text{A}, T_A = 125^\circ\text{C}$			-250	nA
$V_{GS(OFF)}$ Gate to Source Cutoff Voltage	$V_{DS} = -20\text{V}, I_G = 1\text{nA}$	-1		-4.5	V
V_{GS} Gate Source Voltage	$V_{DS} = 20\text{V}, I_D = 50\mu\text{A}$			-4.2	V
	$V_{DS} = 20\text{V}, I_D = 200\mu\text{A}$	-0.5		-4	V
$V_{GS(F)}$ Gate Source Forward Voltage	$V_{DS} = 0\text{V}, I_G = 1\text{mA}$			2	V
I_{DSS} Drain to Source Saturation Current	$V_{DS} = 20\text{V}, V_{GS} = 0\text{V}$ (Pulsed)	0.5		5	mA

Dynamic Characteristics (@ $T_A = 25^\circ\text{C}$, Unless otherwise specified)

Parameters	Conditions	IFN3954, IFN3955, IFN3956			Unit
		Min	Typ	Max	
G_{FS} Forward Transconductance	$V_{DS} = 10\text{V}, V_{GS} = 0\text{V}, f = 1\text{kHz}$	1000		3000	μS
	$V_{DS} = 20\text{V}, V_{GS} = 0\text{V}, f = 200\text{MHz}$	1000			
G_{OS} Output Conductance	$V_{DS} = 20\text{V}, f = 1\text{kHz}$			35	μS
C_{ISS} Input Capacitance	$V_{DS} = 20\text{V}, V_{GS} = 0\text{V}, f = 1\text{MHz}$			4	pF
C_{RSS} Reverse Capacitance	$V_{DS} = 20\text{V}, V_{GS} = 0\text{V}, f = 1\text{MHz}$			1.2	pF
NF Noise Figure	$V_{DS} = 20\text{V}, f = 10\text{Hz}, R_G = 10\text{M}\Omega$			0.5	dB
$ I_{G1} - I_{G2} $ Differential Gate Current	$V_{DS} = 20\text{V}, I_D = 200\mu\text{A}, T_A = 125^\circ\text{C}$			10	nA
I_{DSS1}/I_{DSS2} Saturation Drain Current Ratio	$V_{DS} = 20\text{V}, V_{GS} = 0\text{V}$	0.95		1	
$ V_{GS1} - V_{GS2} $ Differential Gate Source Voltage	$V_{DS} = 20\text{V}, I_D = 200\mu\text{A}$			5	mV
	IFN3955			10	mV
	IFN3956			15	mV
$\frac{ V_{GS1} - V_{GS2} }{\Delta T}$ Differential Gate Source Voltage with Temperature	$V_{DS} = 20\text{V}, I_D = 200\mu\text{A}$			1	mV/ $^\circ\text{C}$
	$T_0 = -55^\circ\text{C}$ to 125°C			2.5	mV/ $^\circ\text{C}$
	IFN3956			5	mV/ $^\circ\text{C}$
g_{fs1}/g_{fs2} Transconductance Ratio	$V_{DS} = 20\text{V}, I_D = 200\mu\text{A}, f = 1\text{kHz}$	0.97		1	

